IEEE SW Test Workshop

Semiconductor Wafer Test Workshop

Morgan Ku, Phil Hsieh, Jason Ho, Sobers Chang, Seenew Lai, Dick Ho MJC Probe Inc.



The Advanced Cantilever Probe Card with High Bandwidth (>3GHz) and Experimental Result



June 8-11, 2008 San Diego, CA USA

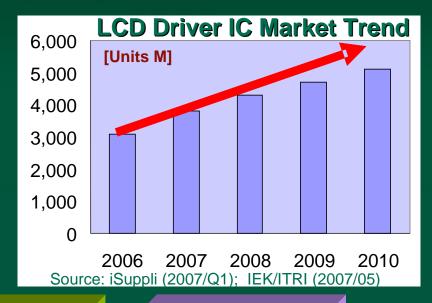
Outline

- Introduction & Background
- Objectives & Goal
- Modeling & Analysis
- Experiment, Validation & Customer Verification
- Summary & Conclusion
- Follow-On Work



Introduction & Background

High Speed Market (LCD, Memory, Logic...)



High Resolution

Fast Response

High Speed Testing



FPC-less

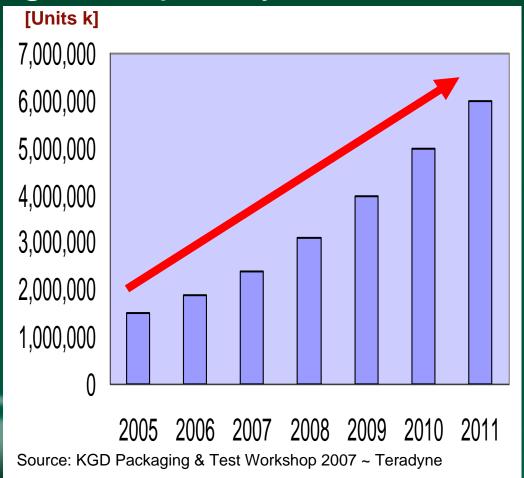
June 8 to 11, 2008

High Color Reproduction

IEEE SW Test Workshop

Introduction & Background

High Frequency Market



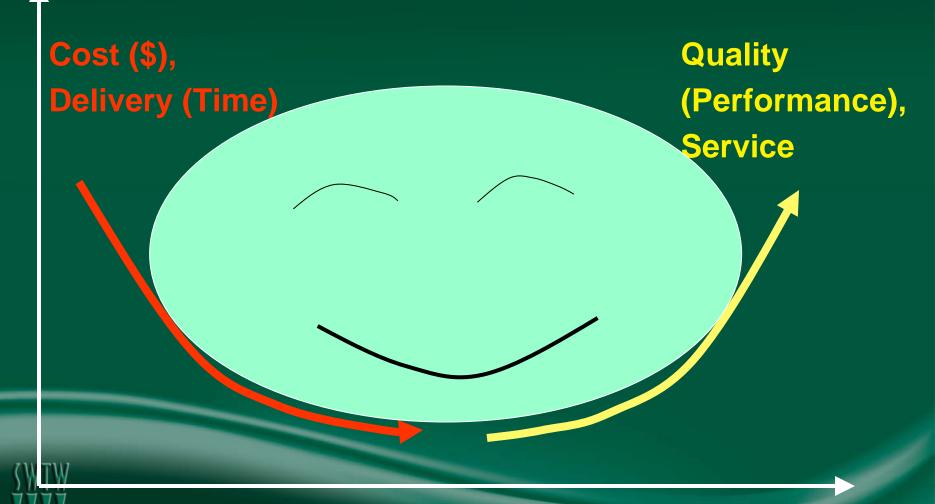
Wireless Devices

- Cellular Handsets
- Cordless Phone
- WLAN
- Bluetooth
- GPS
- UWB
- WiMax
- DVB-H & T-DMB
- Zigbee



Introduction & Background

Customer / Market Requirement – "Smile Curve"

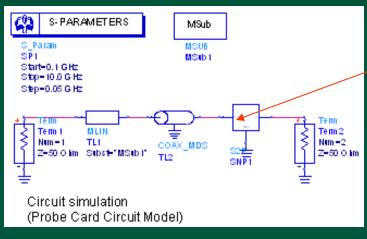


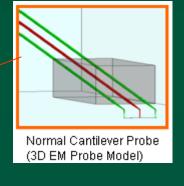
Objectives & Goal

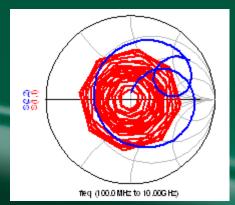
- Objectives Reduce the total cost for high speed device testing
 - High performance (>3GHz, >1Gbps)
 - Low total cost (CP/FT test cost...)
 - Short delivery time (< 2 weeks)
 - Fine pitch (< 35 um)
- Strategy How ??
 - Improve the "Signal Integrity" issue of the normal cantilever probe card.

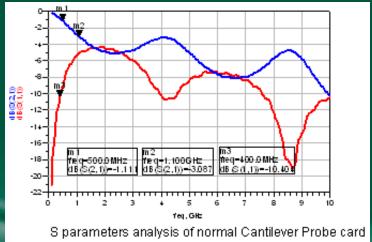


Modeling – The EM model of the probe card
 EM model (Probe), Circuit model (Probe Card)









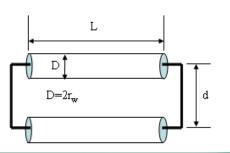
Modeling-Inductance of the cantilever probe

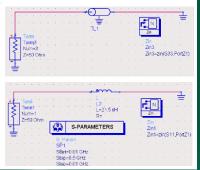


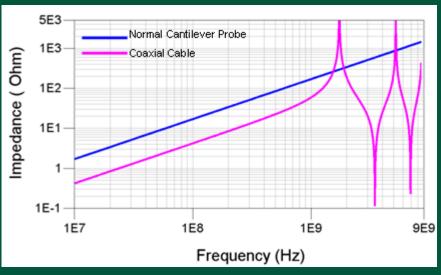
$$L_S = \frac{\mu_0}{2\pi} \, \ell \left\{ \ln \left[\frac{\ell}{d} + \sqrt{\left(\frac{\ell}{d}\right)^2 + 1} \right] + \frac{d}{\ell} - \sqrt{(\frac{d}{\ell})^2 + 1} \right\} \quad \text{Self Inductance}$$

$$L_{M} = \frac{\mu_{0}}{2\pi} \, \ell \left\{ ln \left[\frac{\ell}{r_{w}} + \sqrt{\left(\frac{\ell}{r_{w}}\right)^{2} + 1} \right] + \frac{r_{w}}{\ell} - \sqrt{(\frac{r_{w}}{\ell})^{2} + 1} \right\} \quad \text{Mutual Inductance}$$

$$L_{loop} \cong 2(L_s - L_M)$$
 if $\ell \gg r_w$, $\ell \gg d$



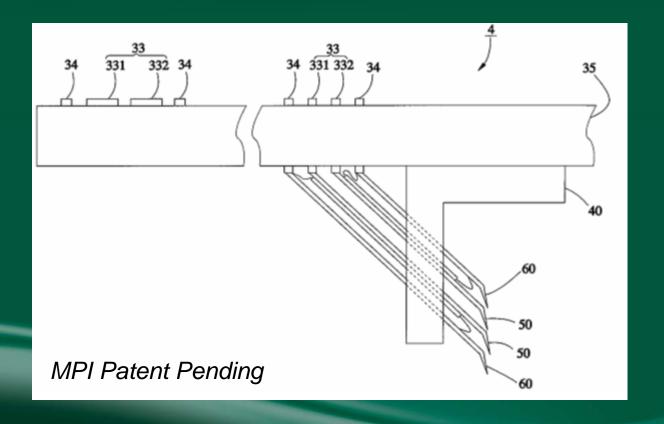




	Formula
Normal Cantilever Probe	21.4nH

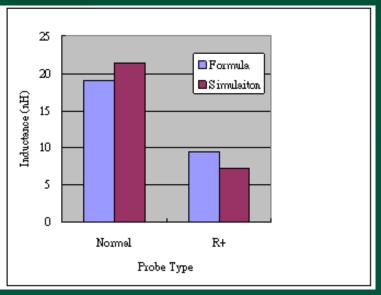


 Modeling – The impedance compensated cantilever probe (R+)

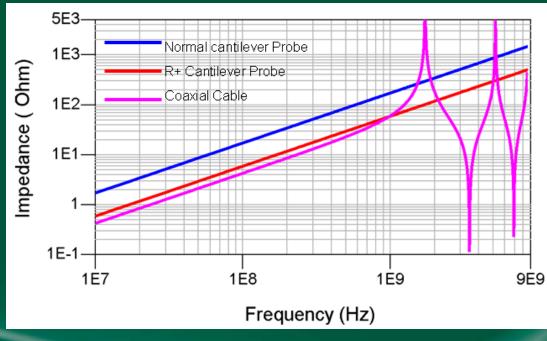




Modeling – Inductance comparison



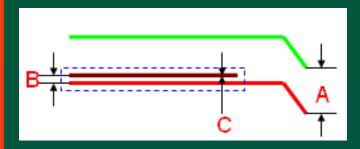
	Formula	HFSS Simulation
Normal Probe	21.4nH	19.1nH
R+ Probe	7.25nH	9.44nH

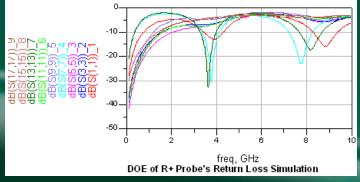


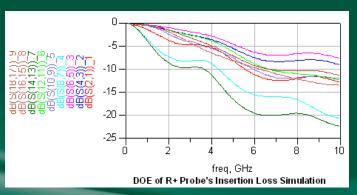


 Improve the R+ probe's impedance matching with DOE method (EM Simulation result)

Ехр.	A (um)	B (mil)	C (mil)	ABC	S21(-1dB)	S21 (-3dB)	S11(-10dB)
1			TOTAL		810 MHz	1.68 GHz	750 MHz
2					1.56 GHz	3.50 GHz	1.57 GHz
3					2 GHz	4.12 GHz	2.05 GHz
4					450 MHz	895 MHz	360 MHz
5					210 MHz	2.27 GHz	1.195 GHz
6					1.64 GHz	3.39 GHz	1.63 GHz
7					460 MHz	850 MHz	355 MHz
8					1.48 GHz	2.48 GHz	1.40 GHz
9	1000				1.65 GHz	2.89 GHz	1.5 GHz







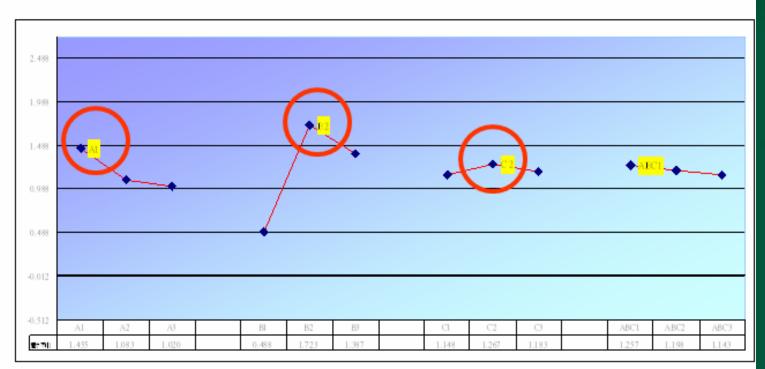
ANOVA

Target: high frequency @ S11(-10dB) Quality judgment: Larger the better ANOVA Result: Pareto Chart 100% 88% 90% 80% 70% 60% 50% Cum% 40% 30% 20% 11% 10% 1% 0% 0% 0% ABC B (mil) A (um) C (mil) Error A (um) High effect from ANOVA result B (mil)



S/N Chart

Factors Effects on S/N Ratio:



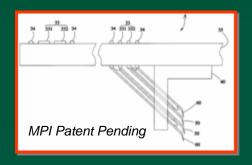
Larger the better

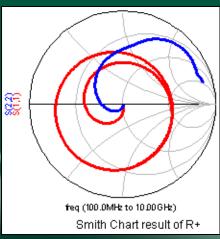
A 1

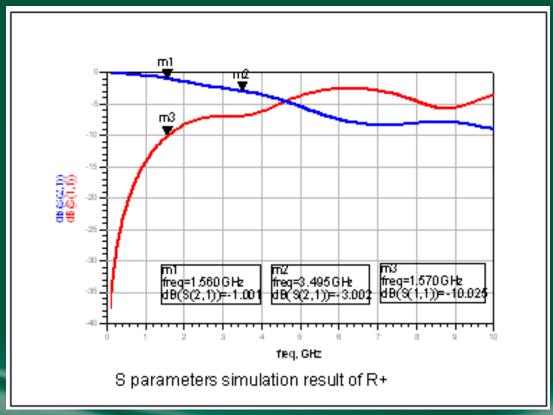
В2

С2

 Modeling – The impedance compensated cantilever probe (R+ probe)

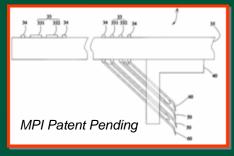


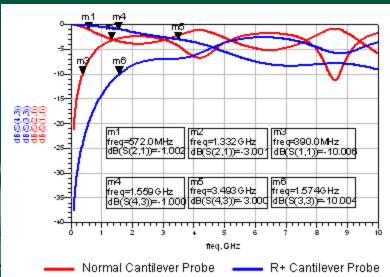


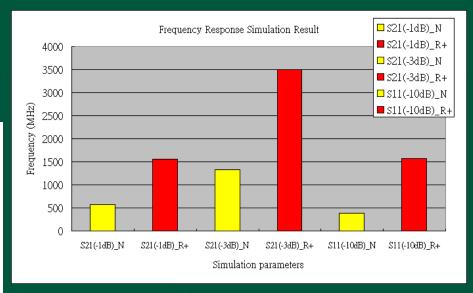




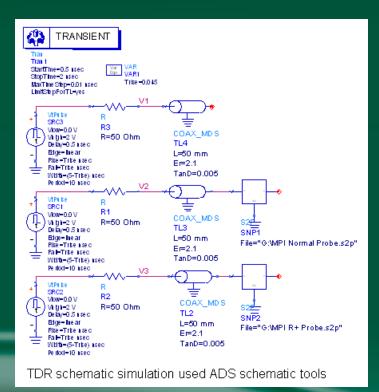
Analysis – Frequency Domain response
 S21,S11 (R+ probe vs. normal probe)

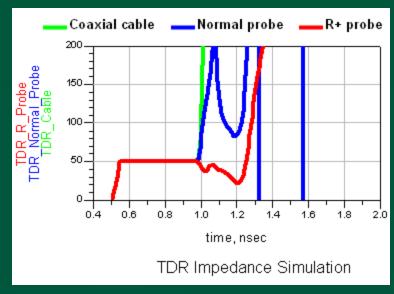






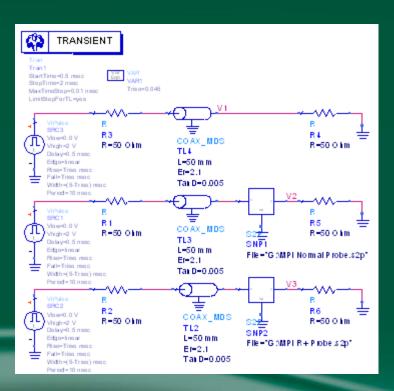
Analysis – Time Domain response
 Impedance (R+ probe vs. normal probe)

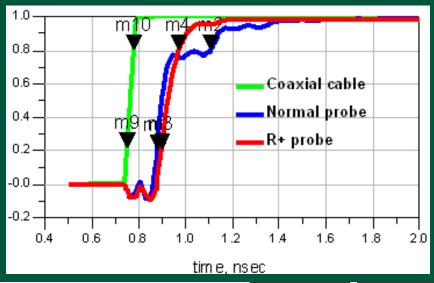


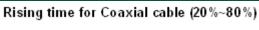




 Analysis – Time Domain response Rising time 20~80% (R+ probe vs. normal probe)







778.3 ps - 751.3 ps = 27 ps

Rising time for Normal probe (20 %~80 %)

1106 ps - 879.3 ps = 226.7 ps

Rising time for R+ probe (20%~80%)

971.3 ps - 899.3 ps = 72 ps

V2=203.3mV

time=879.3psec

m2

time=1.106nsec V2=800.5mV

time=899.3psecl V3=208.6mV

time=971.3psec V3=800.7mV

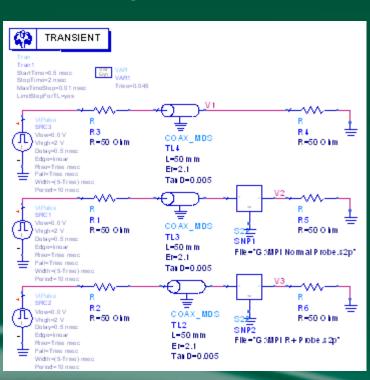
time=751.3psec V1=218.6mV

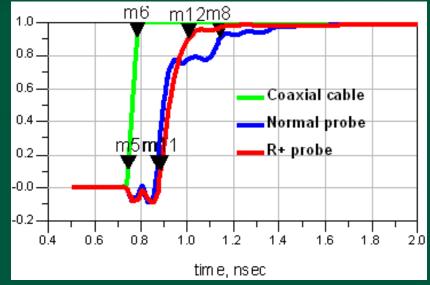
m10 time=778.3psec V1=803 0mV

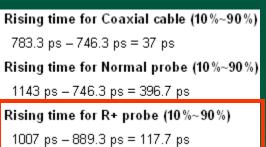


Analysis – Time Domain response

Rising time 10~90% (R+ probe vs. normal probe)







m7 time=871.3psec V2=109.6mV | m12 time=1.007nsec V3=900.2mV

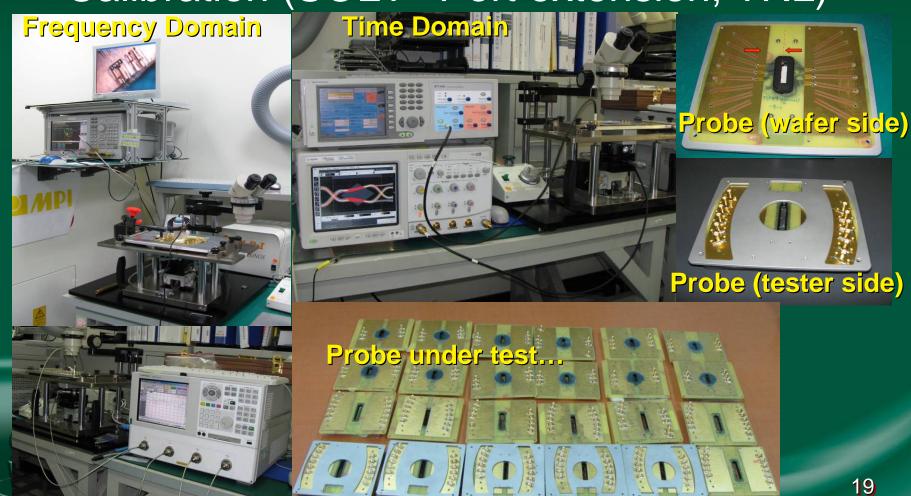
m11 time=889.3psec V3=107.9mV

m6 time=783.3psec V1=911.2mV

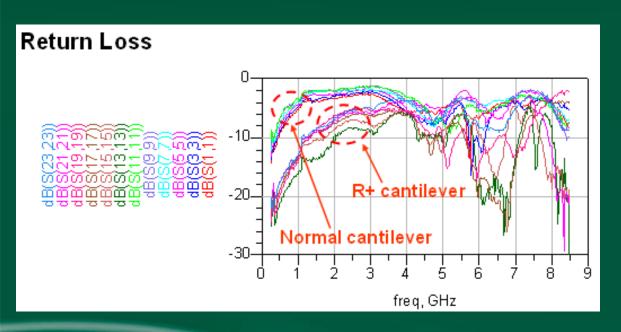


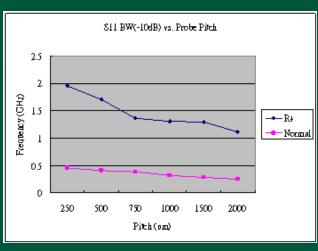
Experiment & Validation Experiment structure

Calibration (SOLT+Port extension, TRL)



Frequency Domain response result
 S11 - R+ probe vs. normal probe





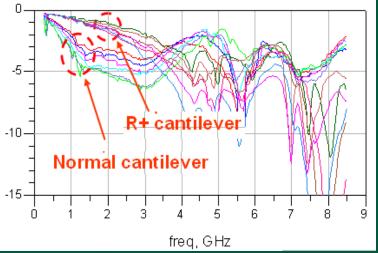


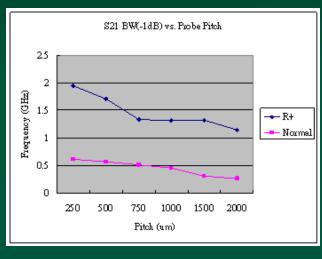
Frequency Domain response result

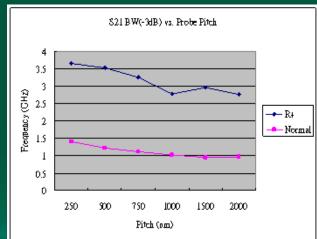
S21 - R+ probe vs. normal probe

Insertion Loss



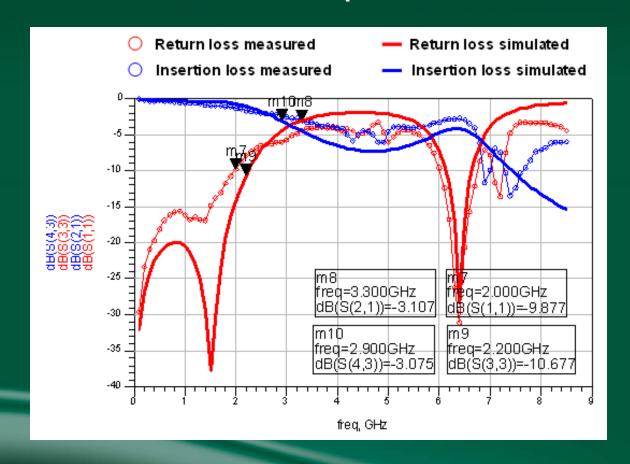






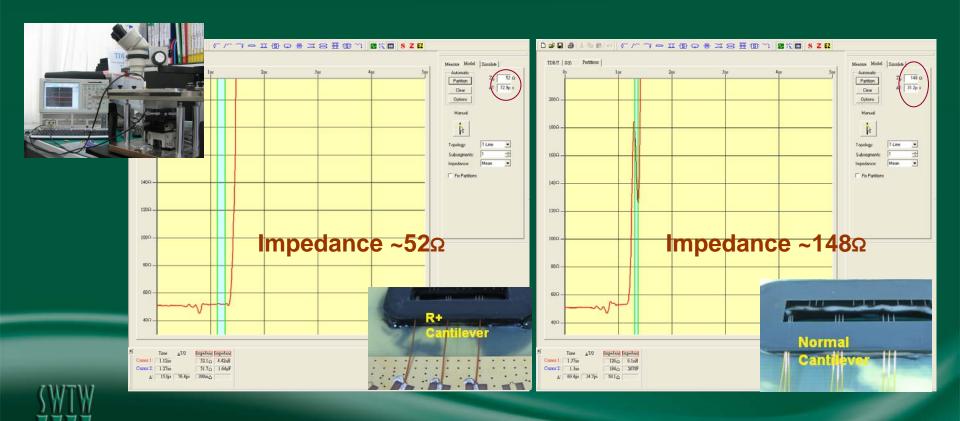


Circuit model vs. experiment result



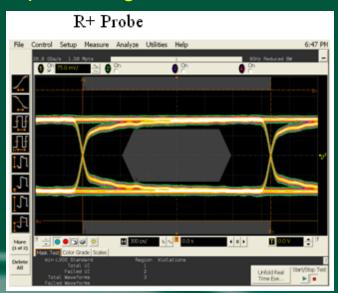


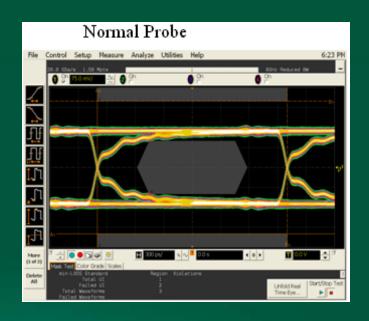
Time Domain response result
 Impedance (R+ probe vs. normal probe)



Time Domain response result
 LCD - mini-LVDS (R+ probe vs. normal probe)

Input Data Rate: 500 Mbps Input Voltage: +/- 150 mV

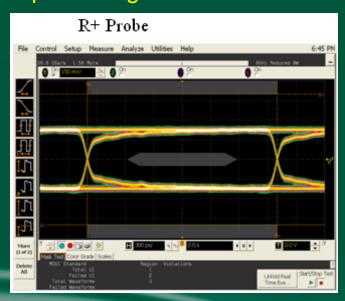


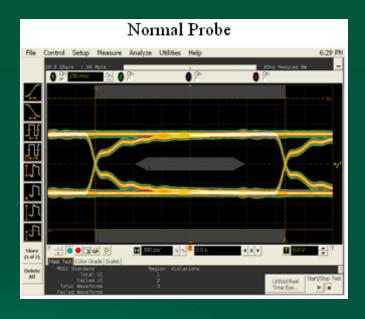




Time Domain response result
 LCD – MDDI (R+ probe vs. normal probe)

Input Data Rate: 500 Mbps Input Voltage: +/- 250 mV



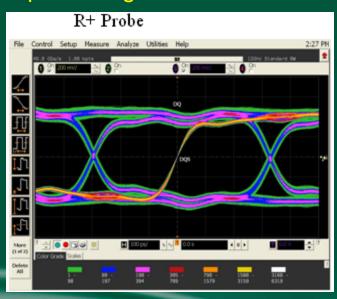


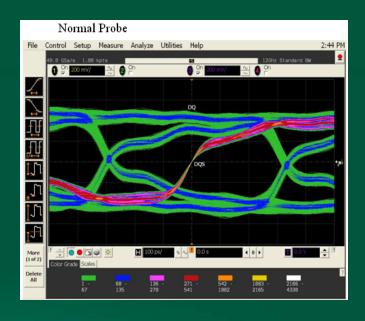


Time Domain response result
 Memory - DDR-III (R+ probe vs. normal probe)

Input Data Rate: 1.6 Gbps

Input Voltage: +/- 1 V

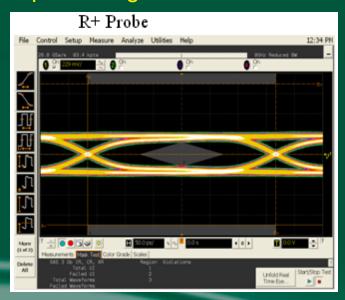


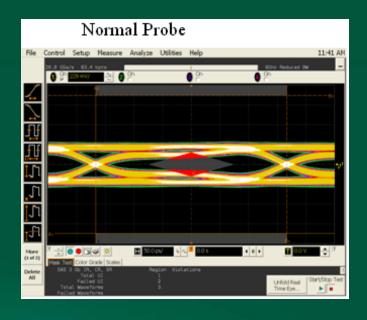




Time Domain response result
 Logic - SATA-II (R+ probe vs. normal probe)

Input Data Rate: 3.0 Gbps Input Voltage: +/- 250 mV

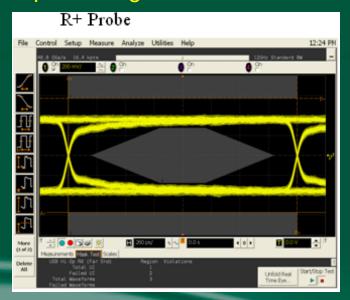


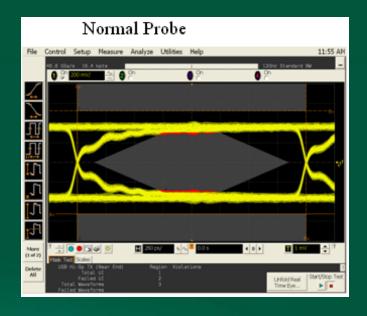




Time Domain response result
 Logic - USB 2.0 (R+ probe vs. normal probe)

Input Data Rate: 480 Mbps Input Voltage: +/- 500 mV



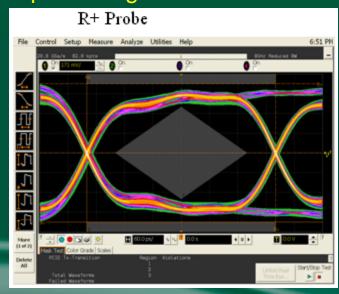


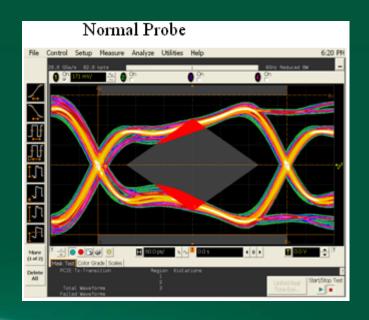


Time Domain response result
 Logic - PCI Express-I (R+ probe vs. normal probe)

PCI E-I (Tx)

Input Data Rate: 2.5GMbps Input Voltage: +/- 650 mV



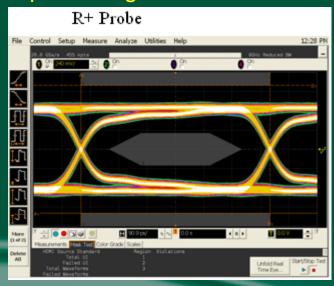


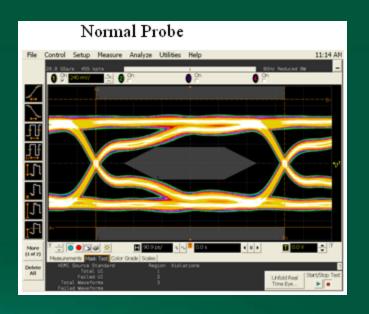


Time Domain response result
 Logic - HDMI (R+ probe vs. normal probe)

HDMI (Source)

Input Data Rate: 2.5 Gbps Input Voltage: +/- 400 mV



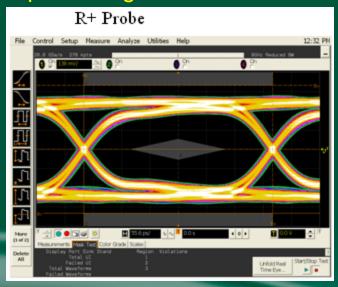


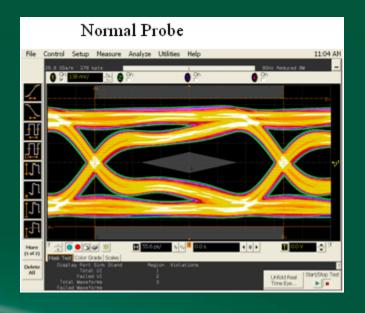


Time Domain response result
 Logic - Display Port (R+ probe vs. normal probe)

Display Port (Sink)

Input Data Rate: 2.7 Gbps Input Voltage: +/- 400 mV







Frequency Domain response result
 R+ probe card (PCB + needle)

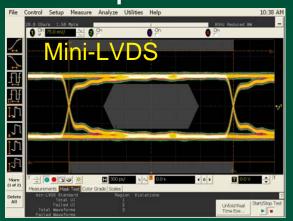


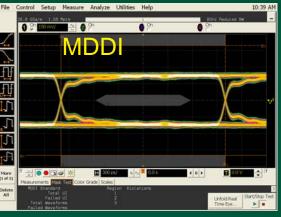


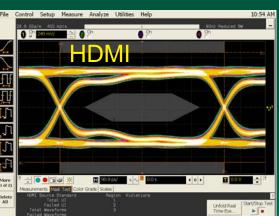


Time Domain response result

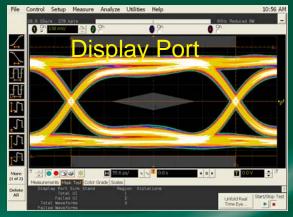
R+ probe card (PCB + needle)











PCI E -

Customer Verification

Shmoo comparison

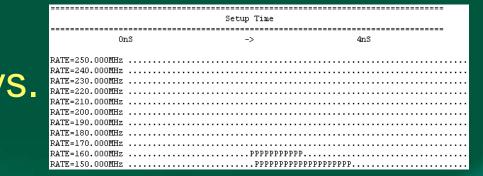
Interface: mini-LVDS

Data Rate: 500 Mbps

Application: Large Panel

R+ Cantilever Probe

Normal Cantilever Probe





Summary & Conclusion

- The probe is the main factor to decrease the frequency bandwidth performance of the cantilever probe card.
- The impedance compensated cantilever probe (R+) has successful been developed and validated the superior SI performance of the probe card. (Patent pending)
- Hundreds of R+ probe cards have been released to mass production of customer's high speed device testing.



Application & Specification

- S21-3dB Bandwidth: > 3GHz
- Inductance: 7~10 nH
- Fine pitch: < 35 um
- Real application of R+ probe cards →
 LCD (mini-LVDS, MDDI, ...), Memory (DDR-III),
 Logic (USB2.0, PCI E-I, ...)
- Lead-time < 2 weeks



Follow-On Work

- Improving the impedance compensated structure toward to the needle tip.
- Ongoing work ~ higher speed device testing probe card for RF application devices.



Acknowledgements

Great thanks to MPI (MJC Probe Inc.) teamwork:

- Tom Peng
- Judy Chen
- Tim Hsu
- Mars Lin
- Mark Sun
- Alex Yang
- Dean Yang
- Vito Lai
- Wensen Hung
- Robert Kao
- Rex Liao



Q & A

Thank you very much.

